AUTOMOTIVE

RoHS

COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

Ultrafast Avalanche SMD Rectifier



SMA (DO-214AC)



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.5 A			
V _{RRM}	1000 V			
I _{FSM}	30 A			
I _R	5.0 μA			
t _{rr}	75 ns			
V _F	1.7 V			
E _R	20 mJ			
T _J max.	150 °C			
Package	SMA (DO-214AC)			
Circuit configuration	Single			

FEATURES

- Low profile package
- Ideal for automated placement
- · Glass passivated pellet chip junction
- Low reverse current
- High reverse voltage
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHE3_X - RoHS-compliant, and AEC-Q101

qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and

AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYG23M	UNIT	
Device marking code		BYG23M		
Maximum repetitive peak reverse voltage	V_{RRM}	1000	V	
Average forward current at T _A = 65 °C	I _{F(AV)}	1.5	А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30	Α	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1$ A, $T_J = 25$ °C	E _R	20	mJ	
Operating junction and storage temperature range	T_J , T_{STG}	-55 to +150	°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	BYG23M	UNIT	
Minimum breakdown voltage	I _R = 100 μA		V_{BR}	1000	V	
Maximum instantaneous voltage	I _F = 1.0 A	T _J = 25 °C	V _F ⁽¹⁾	1.7	V	
		T _J = 150 °C		1.35	V	
Maximum reverse current	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	T _J = 25 °C	- I _R	5	μΑ	
	$V_R = V_{RRM}$	T _J = 125 °C		50		
Maximum reverse recovery time	I _F = 0.5 A, I _R =	1.0 A, I _{rr} = 0.25 A	t _{rr}	75	ns	

Note

 $^{(1)}$ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	BYG23M	UNIT		
Typical thermal resistance, junction to case	$R_{ heta JC}$	25	°C/W		
	R ₀ JA (1)	150			
Typical thermal resistance, junction to ambient	R _{0JA} (2)	125	°C/W		
	R _{0JA} (3)	100			

Notes

- $^{(1)}\,$ Mounted on epoxy-glass hard tissue, 17 mm² 35 μm Cu
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYG23M-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG23M-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG23MHE3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG23MHE3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel	
BYG23M-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYG23M-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	
BYG23MHM3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel	
BYG23MHM3_A/I (1)	0.064	1	7500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

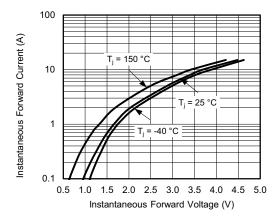


Fig. 1 - Max. Forward Current vs. Forward Voltage

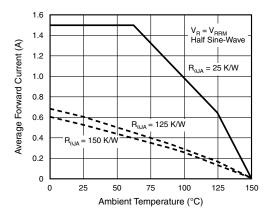


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

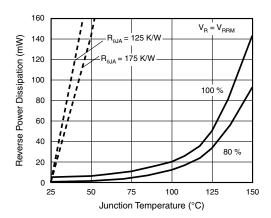


Fig. 3 - Max. Reverse Power Dissipation vs. Junction Temperature

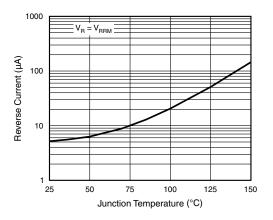


Fig. 4 - Reverse Current vs. Junction Temperature

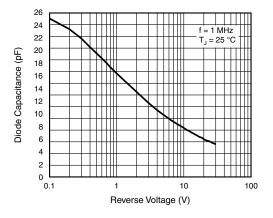


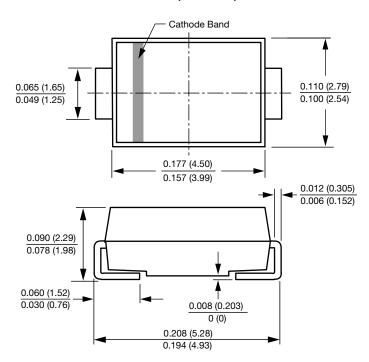
Fig. 5 - Diode Capacitance vs. Reverse Voltage

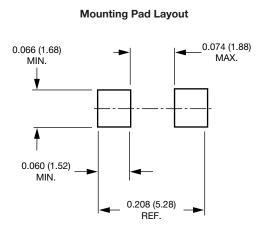


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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)







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